

CA

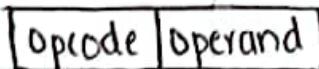
2024 Fall

- i.a) The manner in which each address field specifies the memory location is called addressing mode.

Types:

- (i) Immediate Addressing Mode

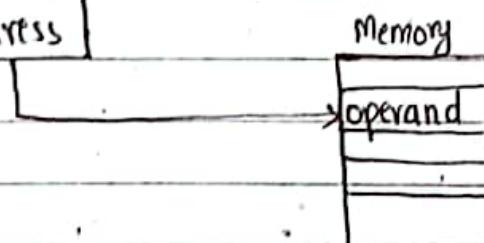
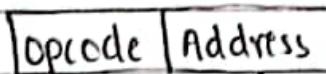
Operand present on instruction itself.



$$E.A. = -$$

operand = A (Address field)

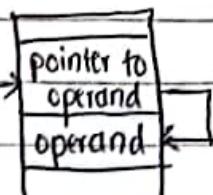
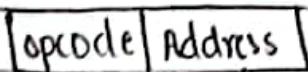
- (ii) Direct Addressing Mode



$$E.A. = A$$

operand = (A)

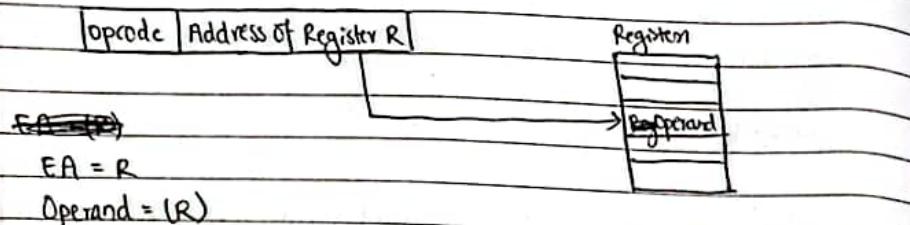
- (iii) Indirect Addressing mode



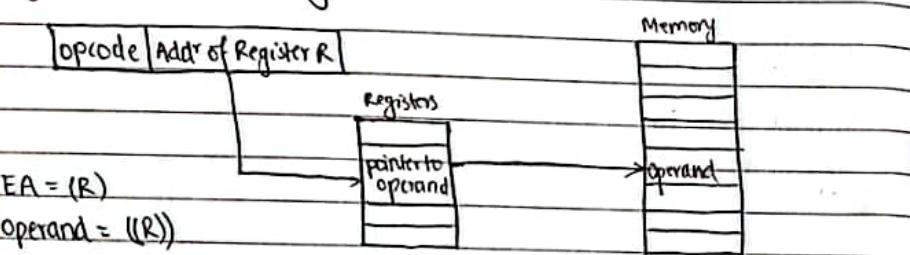
$$E.A. = (A)$$

Operand = ((A))

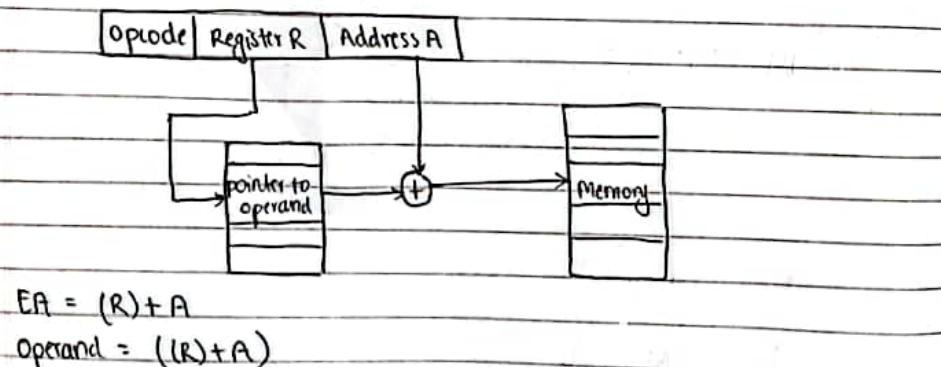
#### (iv) Register Addressing Mode



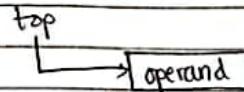
#### (v) Register Indirect Addressing Mode



#### (vi) Displacement Addressing Mode



#### (vii) Stack Addressing Mode



Q1(b)

Data transfer micro-operations in register involves moving binary information from one register to another within CPU. These operations are fundamental for processing instructions and managing data flow inside a computer.

Two techniques of data transfer:

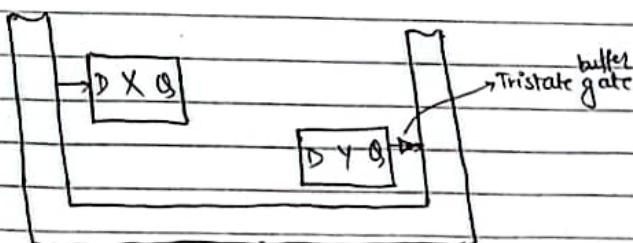
##### 1. Direct (Point-to-point) transfer

- For n registers,  $n(n-1)$  lines.

- If K-bit transfer needed between two register K lines.  
Altogether,  $K \times n(n-1)$



##### 2. Bus Implementation



- All register connect output by using tri-state buffer gate or multiplexer.
- Only one register can transmit data at one time.
  - wiring efficiency
  - scalability
  - Bus contention : only one register use bus at one time.
  - Flexibility

2a)

Internal structure of processor :

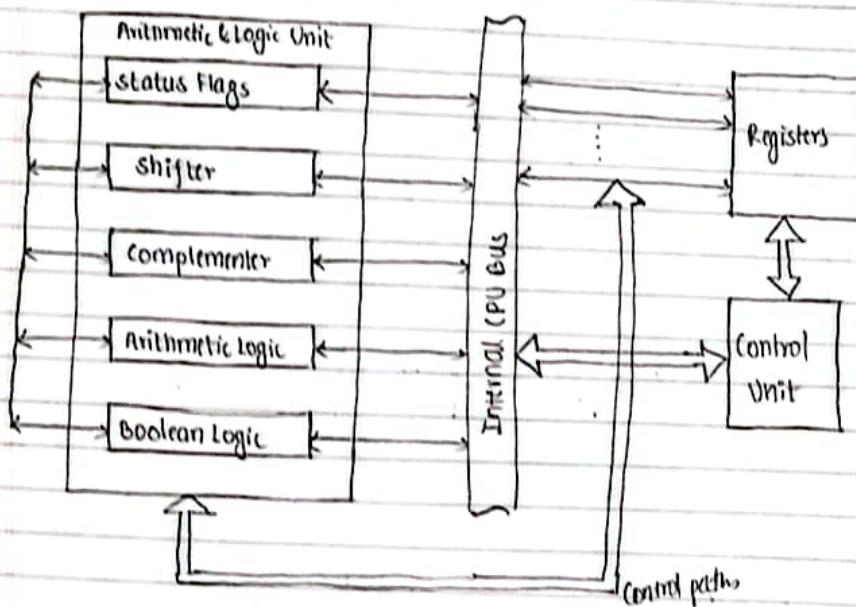


Fig. Internal structure of CPU

### 1. Arithmetic and Logic Unit (ALU)

- Performs all arithmetic and logical operations.
- Key sub-components:
  - # Status Flags : Store results of operation, such as zero, overflow flags
  - # shifter : Handles bit-wise shifting or rotation operations.
  - # Complementer : Performs bitwise complement operations.
  - # Arithmetic Logic : Executes arithmetic operations
  - # Boolean Logic : Executes boolean operations

### 2. Registers

- Small, fast storage units within CPU used to temporarily hold data, instructions, address and results.
- Directly accessible by ALU & Control Unit for fast read/write operations.

### 3. Internal CPU Bus

- Set of parallel lines connecting major components like ALU and registers
- Facilitates data transfer within CPU

### 4. Control Unit

- Generates control signal that coordinate & manage all activities inside CPU.
- Decides which operation to perform, when to move data & what components to engage.

### # Design principle of modern system:

1. Efficient memory utilization
2. Pipelining
3. Parallel processing
4. Uses of caches at different levels
5. Multicore system

2024 Spring.

1b)

$$X = (M \times N) + (P \times Q)$$

### (i) Three Address Instructions

Each instruction can specify three addresses : two for source operands and one for destination.  
For given qsn,

MUL R1, M, N

; R1 = M × N

MUL R2, P, Q

; R2 = P × Q

ADD X, R1, R2

; X = R1 + R2

### (ii) Two Address Instructions

Each instruction can specify two addresses : typically, the destination is also one of the sources.

### (iii) One Address Instruction

A single explicit address is used ; accumulator (AC) is implied as the other operand.

### (iv) Zero-Address Instruction

Use stack.

1b) 1b)  $X = (M \times N) + (P \times Q)$

### (i) 3-Address

MUL R1, M, N

MUL R2, P, Q

ADD X, R1, R2

### (ii) 2-Address :

MUL M, N

MOV R1, M

MUL R1, N

MOV R2, P

MUL R2, Q

ADD R1, R2

MOV X, R1

instruction

comment

; R1 = M

; R1 = R1 × N

; R2 = P

; R2 = R2 × Q

; R1 = R1 + R2

; X = R1

### (iii) 1-Address:

LOAD M

MUL N

STORE TEMP1

LOAD P

MUL Q

ADD TEMP1

STORE X

instruction

comment

; AC = M

; AC = AC × N

; TEMP1 = AC

; AC = P

; AC = AC × Q

; AC = AC + TEMP1

; X = AC

(Uses a memory location  
(TEMP1) for storing results)

### (iv) 0-Address

Instruction

Stack comment

PUSH M

; start M

PUSH N

; start M, N

MUL

(M × N)

PUSH P

(M × N), P

PUSH Q

(M × N), P, Q

MUL

(M × N), (P × Q)

ADD

$(M \times N) + (P \times Q)$

POP X

Empty stack; X = (result)

(a))

### Structure of VHDL Programming :

The structure of VHDL program consists of several fundamental sections that organize how digital circuits are described & implemented.

#### 1. Library Declarations

- Libraries make standard types, functions, and components available for use.

For e.g.

```
library IEEE;
use IEEE.STD.LOGIC.ARITH.ALL;
```

#### 2. Entity Declaration

- The entity block describes how circuit connects to the outside world.
- Defines circuit interface (input/output)
- It is much like declaring pin diagram of IC.
- Declares name of entity and port, specifying their direction (IN, OUT, INOUT) and type (STD-LOGIC etc.)

synopsis e.g.:

```
ENTITY entity-name IS
  PORT (
    port1 : IN STD-LOGIC;
    port2 : OUT STD-LOGIC);
END entity-name;
```

1c	2b	3d	4d	5c	6a	7d	8a	9/b	10d
✓1d	✓2b	✓3b	✓4c	✓5d	✓6a	✓7d	✓8d	✓9b	✓10c
✓2c	✓2a	✓2b	✓2a	✓2b	✓2c	✓2d	✓2b	✓2c	✓3b
✓3c	✓3c	✓3d	✓3b	✓3b	✓3b	✓3d	✓3b	✓3b	✓4d

#### 3. Architecture Section

- Describes the internal operation or behavior of the circuit defined by the entity.
- May contain signal declarations, concurrent statements, component instantiations and so on.

e.g. architecture Behavioral of entity-name is

-- optional declarations (signals, constants, components)

BEGIN

-- concurrent statements (logic, assignments, processes etc.)

END Behavioral;

(b)

### Register types:

#### 1. User visible Registers

- Address register
- Data register
- General purpose register
- Conversion code

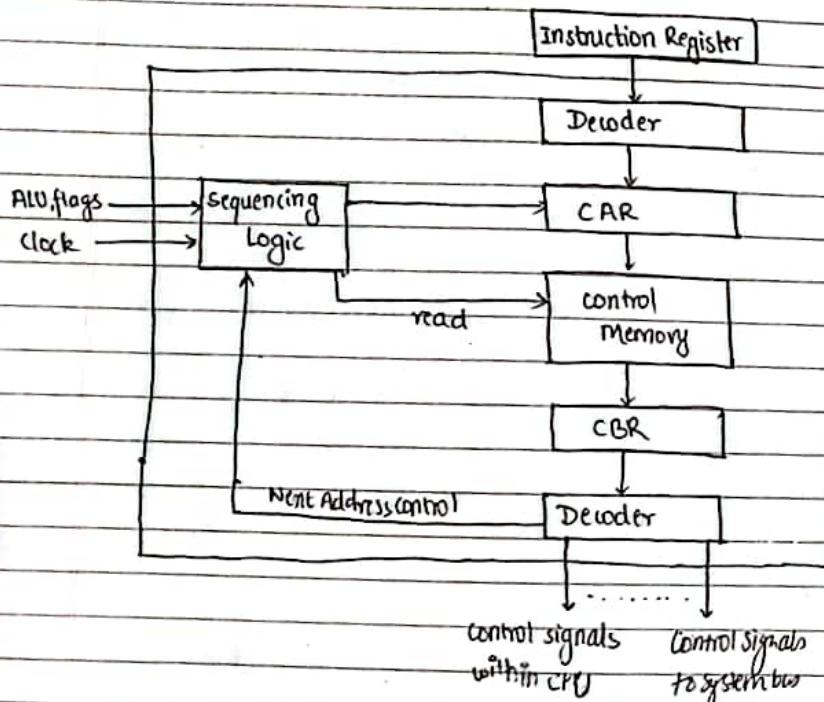
#### 2. Status & control registers

- MAR
- MR
- IR
- PC

Q3(a)

control memory is a type of memory located within control unit that stores microprograms composed of micro instructions.

- In Microprogrammed control unit, control memory is used as Read Only Memory (ROM), where all control information is stored permanently.



### Horizontal μ-instruction

- Every bit of microinstruction correspond to control signal.

Difference b/w Horizontal & vertical microinstruction:

Aspect	Horizontal control unit	Vertical control unit
Control word width	Longer (wide, many bits)	Shorter (narrower, fewer bits)
Control signal specification	Explicit (one bit per control signal)	Encoded (fields decoded to control signals)
Parallelism	High (many operations in parallel)	Low/sequential (few operations at a time)
Hardware Requirement	No extra hardware needed for decoding	Requires decoders to expand control signals.
Flexibility	More flexible, direct hardware control	Less flexible, more like regular instruction
Speed	Faster (direct signal activation)	slower (decoding introduces delay)
Memory requirement	High (large word, more storage needed)	Low (compact, less storage needed)
Micro-instruction type	Each bit controls a separate function.	Encoded field represents sets of operations

$$\begin{array}{r}
 163421 \\
 010001 \\
 \hline
 11110 \\
 000100 \\
 \hline
 000010
 \end{array}
 \quad
 \begin{array}{r}
 11110 \\
 01100 \\
 \hline
 000010
 \end{array}$$

(Q3b)  $17 * 9$  using Booth's

$$010001 * 000100$$

S            M

A	S	$\oplus_1$	M	Operation
000000	010001	0	000100	
111100	010001	0	000100	$A \leftarrow A - M$
111110	001000	1	000100	Ashr
000010	001000	1	000100	$A \leftarrow A / M$
000001	000100	0	000100	Ashr
000000	100010	0	000100	Ashr
000000	010001	0	000100	Ashr
111100	010001	0	000100	$A \leftarrow A - M$
111110	001000	1	000100	Ashr
000010	001000	1	000100	$A \leftarrow A / M$
000001	000100	0	000100	Ashr

Result is stored in A<sub>8</sub>.

$$\begin{array}{r}
 000001\ 000100 \\
 \text{by } 1211101010
 \end{array}
 = 68$$

A<sub>8</sub>

(Q4a)

The pipelining hazards are:

### 1. Resource conflict

It is caused when two segments access memory at same time. These conflicts can be removed by using separate memories for data and instructions.

### 2. Data conflict

It arises when an instruction depends on the result of previous one.

Resolving:

- (i) Hardware interlock
- (ii) Operand forwarding
- (iii) Delayed Load

### 3. Branch conflict

It arises from branch and other instructions that change the value of PC.

Resolutions:

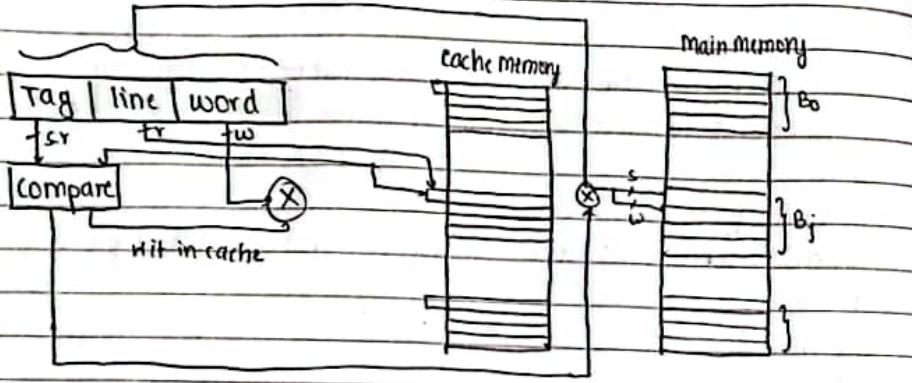
- (i) Branch Prediction
- (ii) Delayed Branch
- (iii) Loop Buffer
- (iv) Prefetch target instruction
- (v) Branch target Buffer

(Q4b)

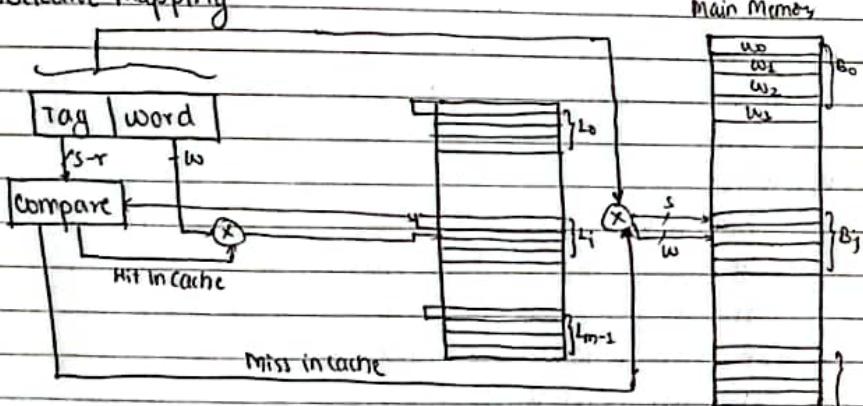
The transformation of data from main memory to cache memory is called mapping process.

### (i) Direct Mapping

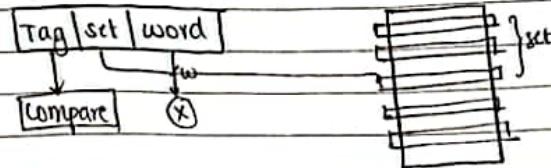
Maps each block of main memory into only one possible cache line.



### (ii) Associative Mapping



### (iii) Set Associative Mapping



(Q5a)

Memory storage devices:

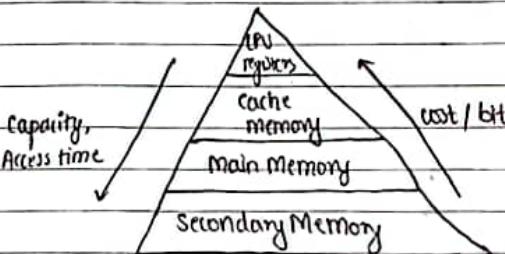


Fig. Memory hierarchy.

#### 1. Registers

These are small, ultra-fast memory locations inside the CPU that hold data and instructions currently needed for processing. They have the quickest access time but minimal storage capacity.

#### 2. Cache Memory

Located close to CPU, cache stores frequently accessed data or instructions to speed up processing.

PTO

### 3. Main Memory

This is the central storage area the CPU can access directly. It stores program data and instructions currently in use and consists of both RAM and ROM.

### 4. Auxiliary Memory

These storage devices, such as hard disk drives (HDD), solid-state drives (SSD) and optical disks, provide large, non-volatile storage for data not currently in use.

### 5. Associative Memory

Special Memory allowing data retrieval by content rather than address, enabling parallel searches.

(Q5b)

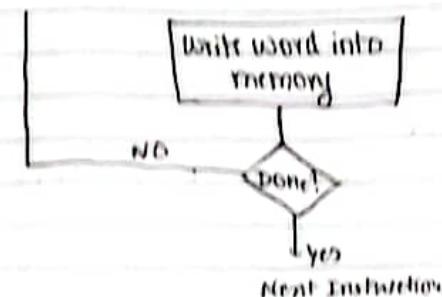
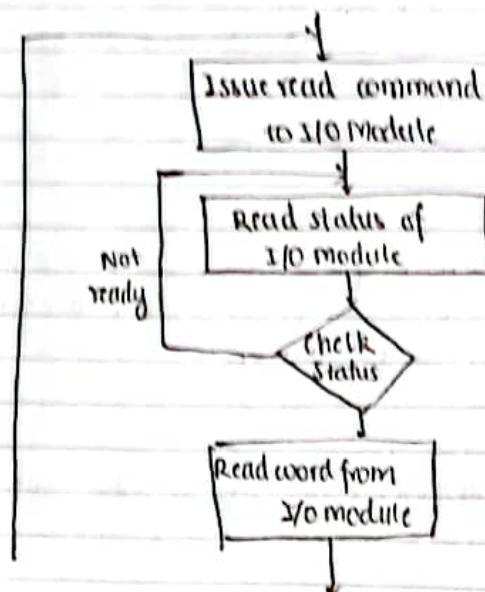
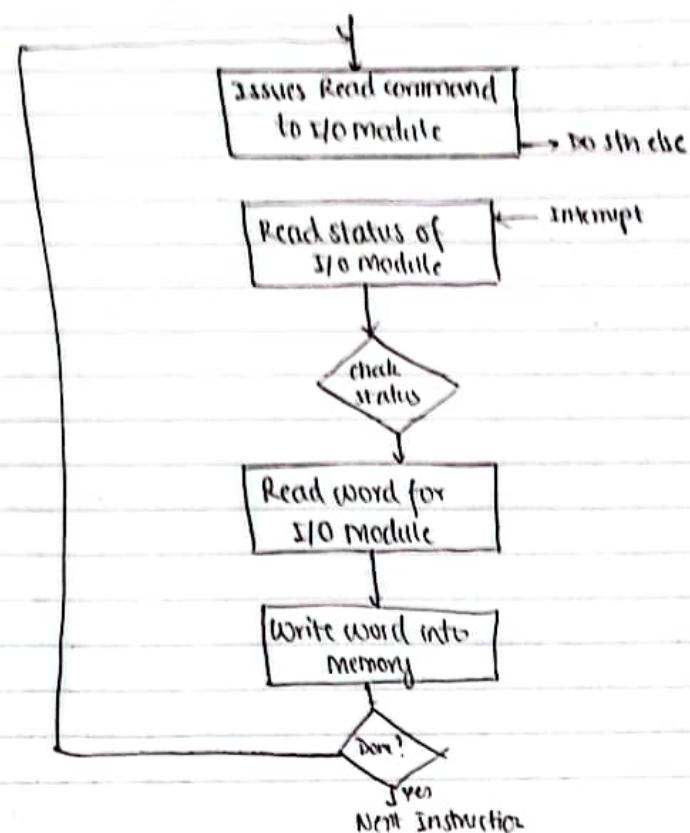
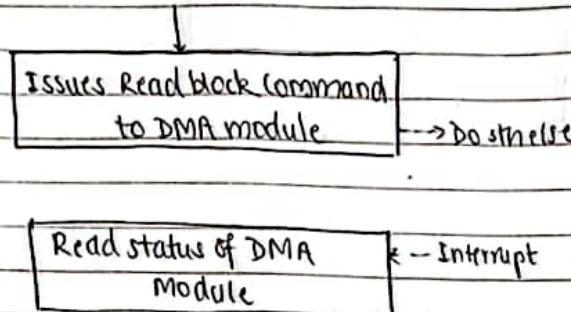


Fig. Programmed I/O

Interrupt driven I/O:



## DMA:



## Software Related Performance issues:

1. Workload Parallelization
2. Thread and Process Management Overheads
3. Load Balancing
4. Cache Coherency Overhead
5. Scalability of Algorithms
6. Software Compatibility & Legacy Applications
7. Operating System Support

Q6(a)

### Elliott's Classification:

- (i) Single Instruction Single Data (SISD)
- (ii) Multiple Instruction Multiple Data (MIMD)
- (iii) Single Instruction Multiple Data (SIMD)
- (iv) Multiple Instruction Single Data (MISD)

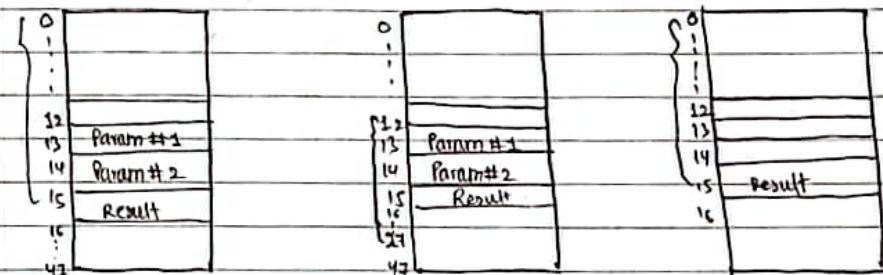
Q6(b)

### Hardware related performance issues:

- (i) Pipeline Limitations and stalls
- (ii) Resource Contention
- (iii) Cache Coherency & Latency
- (iv) Memory bandwidth & Latency
- (v) Power Consumption & Thermal Limits
- (vi) Scalability Limits

Q7(b)

### Register Windowing & Renaming



a) First window active  
only 1<sup>st</sup> window  
has valid data

b) Second window is  
active 1<sup>st</sup> two windows  
have valid data

c) 3<sup>rd</sup> window is active  
Only 1<sup>st</sup> window has  
valid data

Q7c)

### GPU vs TPU

<u>Feature</u>	<u>GPU</u>	<u>TPU</u>
Developer	NVIDIA, AMD, others	Google
Purpose	Originally for graphics; now for parallel tasks & AI	Purpose built for AI, especially tensor operations
Architecture	Thousands of cores for parallelism, general purpose use	custom ASIC, optimized for matrix/tensor ops
Flexibility	Highly flexible; supports many frameworks	Limited; mainly optimized for TensorFlow and JAX
Performance	Excellent for a wide range of AI models	Superior speed for large scale tensor computations in AI
Energy Efficiency	Good, but higher power use under load	Higher efficiency for deep learning workloads
Accessibility	Available for desktops, datacenters, cloud	Cloud based, not sold individually